Four-Output Mini PMIC For Safety Applications

General Description

The MAX20430 is a high-efficiency, four-output DC-DC converter and windowed watchdog. OUT1 is a synchronous step-down converter that converts vehicle battery voltage to 3.3V at up to 2.5A. OUT3 boosts OUT1 to 5V at up to 500mA, while OUT2 and OUT4 low-voltage synchronous step-down converters operate from OUT1 and provide a 0.8V to 3.9875V output voltage range at up to 3A. All outputs achieve $\pm 1.5\%$ output error over load, line, and temperature range.

The device features 2.1MHz fixed-frequency PWM mode for all DC-DC outputs for better noise immunity and load-transient response. The 2.1MHz frequency operation allows for the use of all ceramic capacitors and minimizes external components. The programmable spread-spectrum frequency modulation minimizes radiated electromagnetic emissions. Integrated low R_{DSON} switches improve efficiency at heavy loads and make the layout much simpler with respect to discrete solutions.

The device is offered with factory-preset output voltages. Other features include soft-start, overcurrent, and overtemperature protections.

Applications

ADAS

Benefits and Features

- Multiple Functions for Small Size
 - Synchronous High-Voltage Buck Converter up to 2.5A
 - Input Voltage Range 3.5V to 40V
 - Output Voltage of 3.3V
 - 5V Synchronous 500mA Boost Converter
 - Dual Synchronous Buck Converters up to 3A
 0.8V to 3.9875V in 12.5mV Steps
 - Flexible Power Sequencer for OUT2, OUT3, and OUT4
 - Programmable Challenge/Response or Windowed Watchdog
 - Two Free Programmable UV/OV Voltage Monitors
 0.8V to 3.9875V in 12.5mV Steps
 - I²C Fast Mode Plus Compatible Interface with Packet Error-Checking Option (PEC)
 - 2.1MHz Internal Operation with Spread-Spectrum Option
 - RESET Output
 - Current Mode, Forced PWM Operation
- High-Precision for ASIL Applications
 - ±1.5% Output Voltage Accuracy
 - ±1% OV/UV Monitoring
- Diagnostics and Redundant Circuits
 - ASIL C Compliant
 - Redundant Reference
 - BIST Diagnostics
 - Fail Safe on Open Pins
 - Shorted Pin Detection on RESET
- Mount ID Location Detection
- Robust for the Automotive Environment
- Overtemperature and Short-Circuit Protection
- 5mm x 5mm Side-Wettable TQFN Package
- -40°C to +125°C Grade 1 Automotive Temperature Range

Ordering Information appears at end of datasheet.



Simplified Block Diagram



Four-Output Mini PMIC For Safety Applications

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Absolute Maximum Ratings

V _{SUP} , EN to GND	0.3V to +40V	LX3 to PGND3 (Note 1)0.3V to OUT3 + 0.3V
BST to LX1		LX4 to PGND4 (Note 1)0.3V to PV4 + 0.3V
PV2, PV4 to PGND		GND to PGND0.3V to +0.3V
BIAS, BIASP to GND		Output Short-Circuit DurationContinuous
IN5, IN6 to GND	0.3V to BIAS + 0.3V	Continuous Power Dissipation (T _A = +70°C)
MD1, MD2 to GND		28-TQFN-EP (Single-Layer Board) (derate 65mW/°C >
SCL, SDA, SYNC, RESET to GND		70°C)1702.1mW
OUT1 to GND	0.3V to BIAS+0.3V	28-TQFN-EP (Multilayer Board) (derate 34.5mW/°C >
OUT2 to GND	0.3V to PV2 + 0.3V	70°C.)
OUT4 to GND	0.3V to PV4 + 0.3V	Operating Temperature Range40°C to 125°C
OUT3 to GND		Junction Temperature+150°C
LX1 to PGND1 (Note 1)	0.3V to V _{SUP} + 0.3V	Storage Temperature Range65°C to +150°C
LX2 to PGND2 (Note 1)	0.3V to PV2 + 0.3V	Lead Temperature Range+300°C

Note 1: Self-protected against transient voltages exceeding these limits for ≤ 50ns under normal operation and loads up to the maximum rated output current.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

28-QFN-EP

Package Code	T2855Y+12C
Outline Number	<u>21-100297</u>
Land Pattern Number	<u>90-100102</u>
Thermal Resistance, Four-Layer Board:	
Junction to Ambient (θ _{JA})	29°C/W
Junction to Case (θ_{JC})	2°C/W

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/thermal-tutorial</u>.

Electrical Characteristics

 $(V_{SUP} = V_{EN} = 13.5V, V_{OUT1} = V_{PV2} = V_{PV4} = 3.3V, V_{BIAS} = 5.0V, T_A = TJ = -40^{\circ}C$ to +125°C unless otherwise noted, typical values are at T_A = 25°C under normal conditions unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Supply Voltage Denge	Maria	Fully operational, no BIAS switchover	3.5		36	v
Supply Voltage Range	V _{SUP}	< 1s			40	
Supply Current	1	EN = low		7	50	μA
Supply Current	ISUP	No load, EN = high, V _{OUT1} = 3.3V		24		mA
UVLO	UVLO _R	Rising		3.25	3.45	v
UVLO	UVLOF	Falling	2.5	2.83		v
BIAS, BIASP Voltage		No switchover, $V_{SUP} \ge 5.5V$		5		V
BIAS Current Limit			10			mA

Electrical Characteristics (continued)

 $(V_{SUP} = V_{EN} = 13.5V, V_{OUT1} = V_{PV2} = V_{PV4} = 3.3V, V_{BIAS} = 5.0V, T_A = TJ = -40^{\circ}C$ to +125°C unless otherwise noted, typical values are at $T_A = 25^{\circ}C$ under normal conditions unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
OUT1 (HV BUCK)						
Voltage Accuracy			-1.5		1.5	%
Line Regulation		V _{SUP} = 6V to 36V		0.02		%/V
DMOS High-Side On- Resistance		V _{BIAS} = 5V, I _{LX1} = 0.1A		52	130	mΩ
DMOS Low-Side On- Resistance		V _{BIAS} = 5V, I _{LX1} = 0.1A		47	110	mΩ
High-Side Current-Limit Threshold			3.5	4	4.5	А
Negative Current-Limit Threshold				-1.6		А
Minimum On-Time				65	80	ns
Max Duty Cycle			98	99		%
Switching Phase				0		deg
Soft-Start Time				0.9		ms
OUT2/OUT4 (LV BUCK)						
Supply Voltage Range	V _{PV2} ,V _{PV4}		3		5.5	V
Voltage Accuracy	V _{OUT2} ,V _{OUT4}	I_{LOAD} = 0A to I_{MAX} , 3.0V $\leq V_{PV} \leq 5.5V$	-1.5		1.5	%
HS pMOS On- Resistance		I _{LX_} = 0.2A		82	150	mΩ
LS nMOS On- Resistance		I _{LX} _= 0.2A		50	115	mΩ
		Option 1 (1A)	1.4	1.8	2.4	
HS Current-Limit Threshold		Option 2 (2A)	2.8	3.5	4.6	A
Theshold		Option 3 (3A)	4.2	5.8	6.9	
LX2, LX4 Leakage Current		V _{PV} _= 5.5V, LX_= PGND or PV, T _A = 25°C		1		μA
Negative Current-Limit Threshold				-1		A
Minimum On Time				48	68	ns
Maximum Duty Cycle					100	%
LX2, LX4 Discharge Resistance		Output disabled		47	100	Ω
Switching Phase				180		deg
Soft-Start Time				0.9		ms
OUT3 (BOOST)						
Voltage Accuracy	V _{OUT3}	$I_{LOAD} = 0A \text{ to } I_{MAX}$	4.925	5	5.075	V
PMOS On-Resistance		I _{LX3} = 0.19A		125	250	mΩ
NMOS On-Resistance		I _{LX3} = 0.19A		65	130	mΩ

Electrical Characteristics (continued)

 $(V_{SUP} = V_{EN} = 13.5V, V_{OUT1} = V_{PV2} = V_{PV4} = 3.3V, V_{BIAS} = 5.0V, T_A = TJ = -40^{\circ}C$ to +125°C unless otherwise noted, typical values are at $T_A = 25^{\circ}C$ under normal conditions unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
NMOS Current-Limit Threshold			1.4	2.1	2.7	А
PMOS Negative Current Limit				-500		mA
LX3 Leakage Current		OUT3 = 5.5 V, LX3 = PGND3 or OUT3, T _A = 25°C		1		μA
Maximum Duty Cycle				90		%
OUT3 Discharge Resistance		OUT3 Disabled		340		Ω
Switching Phase				30		deg
Soft-Start Time				1		ms
MD1-2						
Supply Voltage Range			6		36	V
High-Side Wetting Current		MD_ short to ground	10.2	13.6	17	mA
Low-Side Wetting Current		MD_ short to 13.5V	-10.2	-13.6	-17	mA
Input Low Comparator Threshold		9V ≤ V _{SUP} ≤ 16V	V _{SUP} x 0.35	V _{SUP} х 0.25	V _{SUP} x 0.15	V
Input High Comparator Threshold		9V ≤ V _{SUP} ≤ 16V	V _{SUP} x 0.65	V _{SUP} х 0.75	V _{SUP} x 0.85	V
Pullup Resistor			25	50	75	kΩ
Pulldown Resistor			25	50	75	kΩ
Open Voltage		Pin open, CONFIGM = 0x0F	V _{SUP} x 0.45	V _{SUP} х 0.50	V _{SUP} x 0.55	V
ANALOG (IN5, IN6)						
Input Current	I _{IN_}	V _{IN5} /V _{IN6} = 1.8V, Set point programmed to 1.8V		20		μA
V _{IN} Programmable Range		12.5 mV increments	0.8		3.9875	V
		At OTP configured setpoint	-1		1	0/
OV/UV Accuracy		Over full range when changing via I2C	-1.5		1.5	%
OV Threshold				104		%
UV Threshold				96		%
Analog Delay Filter		10% below/above threshold		2	4	μs
OSCILLATOR		·				
Frequency	f _{SW}	Internally Generated	1.95	2.1	2.25	MHz
Spread Spectrum		CONFIG1.SSE = 1 (pseudo-random)		±3		%
THERMAL OVERLOAD		•				
Thermal Shutdown Temperature		T _J rising		175		°C

Electrical Characteristics (continued)

 $(V_{SUP} = V_{EN} = 13.5V, V_{OUT1} = V_{PV2} = V_{PV4} = 3.3V, V_{BIAS} = 5.0V, T_A = TJ = -40^{\circ}C$ to +125°C unless otherwise noted, typical values are at $T_A = 25^{\circ}C$ under normal conditions unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Hysteresis				15		°C
RESET (OUT1-4)			I			1
OV Threshold		Rising	103	104	105	%
UV Threshold		Falling	95	96	97	%
		HT[1:0] = 00		9.8		
		HT[1:0] = 01		19.5		1
Active Hold Period	t _H	HT[1:0] = 10		29.3		- ms
		HT[1:0] = 11		39.0		1
Delay Filter		10% below/above threshold		2	4	μs
Output-High Leakage Current		T _A = 25°C		1		μA
Output Low Level		Sinking -2mA			0.2	V
EN			· ·			
Input High Level	V _{IH}		2.4			V
Input Low Level	V _{IL}				0.6	V
Pull-down				1		MΩ
SYNC INPUT			l			1
Input High Level	V _{IH}		1.5			V
Input Low Level	V _{IL}				0.5	V
Input Hysteresis				0.1		V
SYNC Input Pull-down		EN high		100		kΩ
SYNC Input Frequency Range		50% duty cycle	1.5		3	MHz
FPS						
FPS Start Delay from SD1 Soft-Start Done	t _{FPSDLY}			2		μs
	t _{TS1}	TS = '00'		2.4		
	t _{TS2}	TS = '01'		4.9		1
FPS Timeslot	t _{TS3}	TS = '10'		9.8		ms
	t _{TS4}	TS = '11'		19.5		1
I ² C INTERFACE	-	-	·			
Input High Voltage	V _{IH}		1.2			V
Input Low Voltage	V _{IL}				0.5	V
Output Low Voltage	V _{OL}	ISINK = 4mA			0.4	V
Clock Frequency	f _{SCL}				1.1	MHz
Setup Time (Repeated) START	t _{SU:STA}		260			ns
Hold Time (Repeated) START	t _{HD:STA}		260			ns

Electrical Characteristics (continued)

 $(V_{SUP} = V_{EN} = 13.5V, V_{OUT1} = V_{PV2} = V_{PV4} = 3.3V, V_{BIAS} = 5.0V, T_A = TJ = -40^{\circ}C$ to +125°C unless otherwise noted, typical values are at $T_A = 25^{\circ}C$ under normal conditions unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SCL Low Time	t _{LOW}		500			ns
SCL High Time	thigh		260			ns
Data Setup Time	t _{SU:DAT}		50			ns
Data Hold Time	thd:dat		0			ns
Setup Time for STOP Condition	tsu:sto		260			ns
Spike Suppression				50		ns
Operating I/O Voltage Range			1.7		3.6	V
		Fast Mode (Note 3)			220	
SCL/SDA Fall Time	t _f	Fast Mode Plus (Note 3)			120	ns

Note 2: Limits are 100% tested at TA = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.

Note 3: Not production tested. Guaranteed by design.

Four-Output Mini PMIC For Safety Applications

Typical Operating Characteristics

(V_{SUP} = EN = 13.5V. T_A = 25°C, unless otherwise noted.)



















Four-Output Mini PMIC For Safety Applications

Typical Operating Characteristics (continued)

(V_{SUP} = EN = 13.5V. T_A = 25°C, unless otherwise noted.)



Four-Output Mini PMIC For Safety Applications

Typical Operating Characteristics (continued)

(V_{SUP} = EN = 13.5V. T_A = 25°C, unless otherwise noted.)



Pin Configuration

MAX20430



Pin Description

PIN	NAME	FUNCTION
1	SYNC	SYNC Input. Connect SYNC to BIAS for a 2.1MHz switching frequency. Connect SYNC to an external clock if a different switching frequency is required.
2	PGND1	Power Ground for OUT1. Connect all PGND pins together.
3	PGND2	Power Ground for OUT2. Connect all PGND pins together.
4	LX2	Inductor Connection for Channel 2. Connect LX2 to the switched side of the inductor.
5	PV2	OUT2 Power Supply Input. This must be connected to OUT1 and bypassed with a 4.7µF ceramic capacitor.
6	OUT2	OUT2 Voltage Sense Input
7	SCL	I ² C Clock Input
8	SDA	I ² C Data I/O
9	IN6	Voltage Monitor Input 6. Connect an external supply that is to be monitored to this input. The OV6/UV6 violation can be mapped to the RESET pin.
10	IN5	Voltage Monitor Input 5. Connect an external supply that is to be monitored to this input. The OV5/UV5 violation can be mapped to the RESET pin.
11	PV4	OUT4 Power Supply Input. This must be connected to OUT1 and bypassed with a 4.7µF ceramic capacitor.
12	LX4	Inductor Connection for Channel 4. Connect LX4 to the switched side of the inductor.
13	PGND4	Power Ground for OUT4. Connect all PGND pins together.
14	PGND3	Power Ground for OUT3. Connect all PGND pins together.
15	LX3	Inductor Connection for Channel 3. Connect LX3 to the switched side of the inductor.
16	OUT3	OUT3 Voltage Output

Pin Description (continued)

PIN	NAME	FUNCTION
17	OUT4	OUT4 Voltage-Sense Input
18	GND	Ground
19	BIAS	High voltage LDO output, regulates at 5V. Connect a 2.2uF ceramic capacitor from BIAS to GND.
20	BIASP	Noisy high voltage LDO output, regulates at 5V. Connect a 2.2µF ceramic capacitor from BIASP to GND. After boost converter finishes softstart, this pin connects to OUT3.
21	OUT1	OUT1 Voltage Sense Input
22	MD2	Mount ID Input 2
23	MD1	Mount ID Input 1
24	BST	Bootstrap Capacitor Connection. Connect a 0.1µF ceramic capacitor from BST to LX1.
25	EN	Active-High Enable Input. Drive EN HIGH for normal operation. The IC will power sequence all outputs as factory programmed.
26	V _{SUP}	IC Supply Input. Connect a 4.7µF or larger ceramic capacitor from V _{SUP} to PGND1.
27	LX1	Inductor Connection for Channel 1. Connect LX1 to the switched side of the inductor.
28	RESET	Open-Drain Reset Output. This output remains low for the programmed hold time after all mapped outputs have reached their regulation level (see the Electrical Characteristics table). To obtain a logic signal, pull up RESET with an external resistor.
	EP	Connect the exposed pad to the ground plane. This is the main path for thermal transfer.

Functional Diagrams

Functional Diagram 1



Detailed Description

The MAX20430 is a high-efficiency, four-output DC-DC converter and a windowed watchdog. OUT1 is a synchronous step-down converter that converts vehicle battery voltage to 3.3V at up to 2.5A. OUT3 boosts OUT1 to 5V at up to 500mA, while OUT2 and OUT4 low-voltage synchronous step-down converters operate from OUT1 and provide a 0.8V to 3.9875V output voltage range at up to 3A.

The programmable spread-spectrum frequency modulation minimizes radiated electromagnetic emissions. Integrated low R_{DSON} switches improve efficiency at heavy loads and make the layout much simpler with respect to discrete solutions.

Challenge/Response Watchdog and Reset Control

The challenge/response watchdog uses a linear feedback shift register (LFSR) to calculate the response to the current key. The MCU can read the current key at any time from the WDKEY register. The response must be written after t_{WD1} time expires and before t_{WD2} time expires. The timing of the open and close windows is programmable through the I^2C . Any valid watchdog refresh will terminate the open window and initialize the closed window.

Any assertion of $\overline{\text{RESET}}$ restarts the watchdog. Upon exiting the reset condition (when $\overline{\text{RESET}}$ de-asserts after the expiration of the hold timer), the update window is immediately opened and extended to allow the MCU time to boot before being required to update the watchdog. If the device is configured as a standard windowed watchdog (WDCDIV.SWW = 1) then writing any value to the WDKEY will result in a valid watchdog refresh signal, and the value written will be ignored.

There are three types of watchdog violations: WD_LFSR, WD_EXP, and WD_UV. If configured as a challenge/response watchdog, writing the incorrect response to the WDKEY register will result in the written value being ignored and an LFSR violation. Writing the correct response in challenge/response mode during an open window will result in a refresh and the WDKEY register being updated. Writing the correct response in challenge/response mode during a closed window will result in the write being ignored and a UV violation. Not refreshing the watchdog during the open window will result in an EXP violation.

If a watchdog violation is detected, the watchdog will assert **RESET**, and re-start upon exiting the reset condition. The internal violation counter is reset only during power-on.

The watchdog is enabled when WD_EN bit is 1 and the RESET pin is de-asserted. The WD_LOCK bit must be set to 0 to configure or disable the watchdog to prevent unintended re-configuring of the watchdog.

When the watchdog is configured as a simple windowed watchdog, it can be refreshed by writing any value to the WDKEY register, though the written value will be ignored.



Figure 1. Watchdog Control

Flexible Power Sequencer (FPS)

When EN goes high, the device is powered on and the OUT1 channel is enabled. Once the OUT1 channel has reached a nominal voltage, the flexible power sequencer (FPS) power-up sequence begins. The time between power-up time slots is factory-selectable between values of 2.5ms (typ), 4.9ms (typ), 9.8ms (typ),and 19.5ms (typ). When the EN pin goes low, the device turns off.

A POR_RST event can re-initialize the FPS to the programmed time slots set in the PUx[1:0] registers. For this operation, the RSTMAP[6:1] bits must be cleared.

Four-Output Mini PMIC For Safety Applications

Flexible Power Sequencer Timing



Figure 2. Flexible Power Sequencer (FPS) Timing

RESET Output

The device features an open-drain reset output that asserts low when the corresponding mapped output voltages are outside the UV/OV window, UVLO is asserted, or a watchdog violation occurs. RESET remains asserted for a fixed hold-timeout period after the mapped inputs rise to the regulated voltage. The fixed hold-timeout period is selectable with the HT[1:0] register bits as 9.8ms (typ), 19.5ms(typ), 29.3ms(typ), or 39ms(typ). To obtain a logic signal, place a pullup resistor between the RESET pin and the system I/O voltage. The source mapping to this pin is fully programmable.

Enable Input Pin (EN)

The EN pin is an active-high enable input. When the EN pin goes high, the four DC-DC converters power up in the programmed order. OUT1 must power up first since all other DC-DC converters are cascaded from OUT1. If the EN pin is brought low before the device has finished initializing, the device will stay on for up to 1ms (typ) while a shutdown is executed. The device can be kept enabled by setting the EN_HOLD bit to 1 in the CONFIG1 register. See Figure 3; EN_HOLD is cleared to 0 when the RESET pin is asserted to prevent the power supply from getting stuck on.



Figure 3. Power-On Control State Diagram

Mount ID Input Pins (MD1, MD2)

The MD1 and MD2 inputs are used to identify the location of the module using the connector keying method. The MAX20430 provides a wetting current of 10mA (min). The pins handle loss of ground, which is indicated by -16V(min) on the connector pin.

The procedure for reading the state and setting the wetting current of the MD1 and MD2 pins is as follows:

- 1. After power-up, set CONFIGM to 0x0F, which will enable an internal resistor-divider on MD1/MD2 pins.
- 2. Read register STATM to determine the state.
- 3. Set the wetting current according to the state of each input, and disable the internal resistor-divider. For example, if MD1 is connected to ground, then enable the high-side wetting current.

To verify that the MD1 and MD2 input is functional, complete diagnostics as follows:

- Set CONFIGM to 0x0F, which will enable an internal resistor-divider on the MD1/MD2 pins. If the MD1/MD2 pins are open circuit, the internal resistor-divider will hold the MD1/MD2 pins at mid-rail,(50% x V_{SUP}). Then read register STATM to verify that both MD1/MD2 pins are either high or low, and not mid-rail. A mid-rail MD1/MD2 pin indicates an open-circuit fault.
- 2. Set CONFIGM to 0x1F. Read the STATM register to verify that the MD2 comparator reports high and the MD1 comparator reports low.
- 3. Set CONFIGM to 0x2F. Read the STATM register to verify that the MD2 comparator reports low and the MD1 comparator reports high.
- 4. Set CONFIGM to 0x00 to disable the internal resistor-divider and complete the diagnostics.

Mount ID Diagram



Figure 4. Mount ID Detection (One Channel Shown)

OFF Comparators

The MAX20430 includes an OFF comparator for each output voltage. The comparators assert if the output voltage drops below 0.25V (typ), and are tested for proper operation at power-on. If one of the comparators fails the BIST test, the INTERR bit is set and the comparator state can be read from the status register. The OFF comparators ensure that all outputs assigned to an FPS are discharged before the FPS power-up sequence is initiated.

OV Shutdown Comparators

The MAX20430 includes OV shutdown comparators for each output voltage. If one of the comparators is asserted, then the MAX20430 will turn off all outputs and trigger a UVLO event, reloading OTP and re-running BIST on the comparators. Once power is re-applied, the device powers up normally. If an output is overloaded and the overload is released, it is possible for the output to overshoot and trigger the OV shutdown. OV shutdown comparators are gated with the CONFIGE register, and have no effect on a disabled channel.

UV/OV Comparators

The MAX20430 includes a UV and OV comparator for each output voltage and the voltage on IN5/6. The comparators are tested for proper operation at power-on. If one of the comparators fails the BIST test, the INTERR bit is set in the STATD register. The comparators have a built-in programmable filter time that is controlled by CONFIG2.DF[3:0], which prevents small transients exceeding the UV or OV comparator from triggering a RESET event. This programmable digital filter allows an application-specific setting of filter time up to 28.6µs.

OV and UV comparators are not gated by the CONFIGE register and always report the status of the channel.

Internal Oscillator

The device has a spread-spectrum oscillator that varies the internal operating frequency up by $\pm 3\%$ relative to the internally generated operating frequency of 2.1MHz (typ). The spread frequency generated is psuedorandom with a repeat rate well below the audio band (< 20Hz). Spread spectrum is enabled when CONFIG1.SSE is set to 1.

Overtemperature Protection

Thermal overload protection limits the total power dissipation in the MAX20430. When the junction temperature exceeds 175°C, the device will immediately turn off all output channels and reset the FPS. Once the junction temperature cools by 15°C, the FPS will re-enable and start up according to the programmed sequence.

I²C Interface

The MAX20430 features an I^2 C, 2-wire serial interface consisting of a serial-data line (SDA) and a serial-clock line (SCL). SDA and SCL facilitate communication between the MAX20430 and the master at clock rates up to 1MHz. The master, typically a microcontroller, generates SCL and initiates data transfer on the bus. Figure 5 shows the 2-wire interface timing diagram.

A master device communicates to the MAX20430 by transmitting the proper address followed by the data word. Each transmit sequence is framed by a START (S) or REPEATED START (Sr) condition and a STOP (P) condition. Each word transmitted over the bus is 8 bits long and is always followed by an acknowledge clock pulse.

The MAX20430 SDA line operates as both an input and an open-drain output. The pullup resistor value on the SDA bus should be large enough to keep the open-drain pulldown current less than 4mA (max) to guarantee the MAX20430 can pull SDA below 0.4V. The MAX20430 SCL line operates as an input only. The SCL and SDA inputs suppress noise spikes to assure proper device operation, even on a noisy bus.

Timing Diagram



Figure 5. I²C Timing Diagram

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals (see the START and STOP Conditions section). SDA and SCL idle high when the I^2C bus is not busy.

STOP and START Conditions

A master device initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high (Figure 6). A START (S) condition from the master signals the beginning of a transmission to the MAX20430. The master terminates transmission and frees the bus by issuing a STOP (P) condition. The bus remains active if a REPEATED START (Sr) condition is

generated instead of a STOP condition.

START, STOP, and REPEATED START Conditions



Figure 6. START, STOP, and REPEATED START Conditions

Early STOP Condition

The MAX20430 recognizes a STOP condition at any point during data transmission unless the STOP condition occurs in the same high pulse as a START condition.

Clock Stretching

In general, the clock signal generation for the I²C bus is the responsibility of the master device. The I²C specification allows slow slave devices to alter the clock signal by holding down the clock line, a process typically called clock stretching. The MAX20430 does not use any form of clock stretching to hold down the clock line.

I²C General Call Address

The MAX20430 does not implement the I²C specification's general call address. If the MAX20430 detects the general call address (0b0000_0000) it will not issue an acknowledge.

Packet Error Checking (PEC)

In order to increase fault coverage on the I²C interface, an optional packet error checking (PEC) byte is supported. This follows the SMBus implementation, which has a CRC-8 polynomial of $x^8 + x^2 + x + 1$. The PEC calculation does not include ACK, NACK, START, STOP, nor Repeated START bits. This means that the PEC is computed over the entire message from the first START condition. Only 1 byte can be written per I²C packet. Any data after the PEC byte will not be written.

If PEC is enabled (PECE = 1), the device will NACK an incorrect PEC byte and the written register data will be ignored.

Slave Address

The address is defined as the seven most significant bits (MSbs) followed by the R/W bit. Set the R/W bit to 1 to configure the device to read mode. Set the R/W bit to 0 to configure the device to write mode. The address is the first byte of information sent to the device after the START condition. The slave address is factory preset (see Ordering Information for the 7-bit address for each version). The factory-programmable I²C addresses are 0x38 through 0x3B.

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Acknowledge

The acknowledge bit (ACK) is a clocked ninth bit that the device uses to handshake receipt of each data byte Figure <u>7</u>. The device pulls down SDA during the master-generated ninth clock pulse. The SDA line must remain stable and low during the high period of the acknowledge clock pulse. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master can reattempt communication.

If packet error checking (PEC) is enabled (PECE = 1), the device will NACK an incorrect PEC byte and the written register data will be ignored.

Acknowledge Condition



Figure 7. Acknowledge Condition

Write Data Format

A write to the device includes transmission of the following:

- START condition
- Slave address with the write bit set to 0
- 1 byte of data to register address
- 1 byte of data to the command register
- STOP condition

Figure 8 illustrates the proper format for one frame.

Read Data Format

A read from the device includes the following:

- Transmission of a START condition
- Slave address with the write bit set to 0
- 1 byte of data to register address
- Restart condition
- Slave address with read bit set to 1
- 1 byte of data to the command register
- STOP condition

Figure 8 illustrates the proper format for one frame.

Data Format of I²C Interface

S	Slave Address	0	A	Register Address	A		Data	A	Р						
Write	Sequenital Bytes]						
s	Slave Address	0	A	Register Address	A		Data	А		Data Byte N		A	Ρ		
Write	Byte (PEC Enabled)														
s	Slave Address	0	A	Register Address	A		Data 1	A		PEC A	Р				
1 1															
Read	l Byte	-1													
Read	l Byte Slave Address	0	A	Register Address	A	Sr	Slave Address	1	A	Data Byte	NA	Ρ			
S			A	Register Address	A	Sr		1	A	Data Byte	NA	Ρ			
S	Slave Address		A	Register Address Register Address	A	Sr Sr		1		Data Byte Data Byte	A N	Ρ	PEC	N A P	
S Read	Slave Address						Address				A	Ρ	PEC		

Figure 8. Data Format of I²C Interface

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Register Map

USER

ADDRESS	NAME	MSB							LSB
USER_CMD)S	L		1	1	1	1	1	1
0x00	CID[7:0]	R[′	1:0]			ID[5:0]		
0x01	CONFIG1[7:0]	_	-	– – ^{EN_HOL} SSE PROT PE					PECE
0x02	CONFIG2[7:0]	HT[[1:0]	TS[1:0]		DF[[3:0]	
0x03	CONFIGE[7:0]	-	-	-	-		EN[4:2]		-
0x04	CONFIGM[7:0]	_	-	DIAG	G[1:0]	WCC	2[1:0]	WCC	1[1:0]
0x05	FPSCFG1[7:0]	PU4	[1:0]	PU3	[1:0]	PU2	[1:0]	_	-
0x06	PORRST[7:0]	_	-	-	_	-	-	_	POR_RS T
0x07	PINMAP1[7:0]	_	-			RSTM	AP[6:1]		
0x08	STATUV[7:0]	_	_			UV[6:1]		
0x09	STATOV[7:0]	_	-			OV	[6:1]		
0x0A	STATOFF[7:0]	_	-			OFF	[6:1]		
0x0B	STATD[7:0]	_	-	_	RSTERR	POR	-	THSD	INTERR
0x0C	STATM[7:0]	_	_	_	_	MD2H	MD2L	MD1H	MD1L
0x0D	<u>STATWD[7:0]</u>	_	_	_	RESETB _STAT	WD_OP EN	WD_LFS R	WD_UV	WD_EX P
0x0E	VOUT2[7:0]				OUT	2[7:0]			
0x0F	VOUT4[7:0]				OUT	4[7:0]			
0x10	VIN5[7:0]				IN5	[7:0]			
0x11	VIN6[7:0]				IN6	[7:0]			
0x12	WDCDIV[7:0]	_	WD_SW W						
0x13	WDCFG1[7:0]		WD_O	OPN[3:0] WD_CLO[3:0]					
0x14	WDCFG2[7:0]	-	_	_	_	WD_EN	V	VD_1UD[2:0	0]
0x15	WDKEY[7:0]			WD_KEY[7:0]					
0x16	WDPROT[7:0]	-	-	_	_	_	_	_	WD_PR OT

Register Details

<u>CID (0x0)</u>

BIT	7	6	5	4	3	2	1	0				
Field	R[1	1:0]		ID[5:0]								
Reset	0b	00										
Access Type	Read	l Only	Write, Read, Ext									

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BITFIELD	BITS	DESCRIPTION	DECODE
R	7:6	Silicon Revision Information	00 = Pass 1 Silicon 01 = Pass 2 Silicon 10 = Pass 3 Silicon 11 = Pass 4 Silicon
ID	5:0	Chip Configuration Identification. This is a unique number identifying the factory configuration of the device. This helps identify/verify the configuration without having to look at all configuration registers.	See ordering information.

CONFIG1 (0x1)

Configuration Register 1 (Read/Write)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	EN_HOLD	SSE	PROT	PECE
Reset	-	_	_	-	OTP	OTP	OTP	OTP
Access Type	-	-	-	-	Write, Read, Ext	Write, Read	Write, Read, Ext	Write, Read

BITFIELD	BITS	DESCRIPTION	DECODE
EN_HOLD	3	Enable Hold. Overrides the EN pin to keep the device enabled. This bit is cleared when RESETB is asserted.	0 = EN pin controls power down 1 = Device enabled. Ignores EN pin state
SSE	2	Spread Spectrum Enable.	0 = Disabled 1 = Enabled
PROT	1	Lock Protection. If this bit is set to 1 by factory default, then it can't be cleared. If 0 by default, then this bit can be changed through the l^2C .	0 = All registers can be written. 1 = Writes are ignored to protected registers.
PECE	0	Packet Error Checking Enable. Set this bit to a 1 to enable PEC or 0 to disable PEC.	0 = Disabled. 1 = Enabled.

CONFIG2 (0x2)

Configuration Register 2 (Read/Write, Protected: writeable when LOCK = 0)

BIT	7	6	5	4	3	2	1	0		
Field	ΗΤ[1:0]	TS	[1:0]		DF[3:0]				
Reset	01	Р	0	TP		OTP				
Access Type	Write,	Read	Write, Read Write, Read							
BITFIELD	BITS		DESCRIPT	ION		D	ECODE			
нт	7:6	amount of til (low) after th		on. This is the SET pin is acti aused the RES	ve 01 = 1 ET 10 = 2	00 = 9.8ms 01 = 19.5ms 10 = 29.3ms 11 = 39ms				
TS	5:4	Time Slot Ti between tim		define the time	e 01 = 4 10 = 9	00 = 2.4ms 01 = 4.9ms 10 = 9.8ms 11 = 19.5ms				
DF	3:0		al Filter. Adds comparators.	additional filteri	ng Added	I Filter Time = DI	F[3:0] x 1.9µs	(±1µs nom)		

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CONFIGE (0x3)

Channel Enable Configuration Register (Read/Write, Protected: writeable when LOCK = 0)

	<u> </u>	<u> </u>							
BIT	7	6	5	4	3	2	1	0	
Field	-	-	-	-		EN[4:2] –			
Reset	-	_	_	-		OTP –			
Access Type	-	-	-	_		Write, Read –			
BITFIELD	BITS		DESCRIPT	ION		D	ECODE		
EN	3:1	OUT3(EN3) When an ou	Enable for OL , and OUT4(EN tput is enabled n the output is o	N4). I, the FPS will	0 = Output Disabled 1 = Output Enabled				

CONFIGM (0x4)

Mount ID Configuration Register (Read/Write)

BIT	7	6	5 4			3	2	1	0
Field	_	_	DIAC	G[1:0]		WCC	2[1:0]	WCC	1[1:0]
Reset	-	_	OTP OTP C					ΓP	
Access Type	_	_	Write	Write, Read Write, Read Write, Read					Read
BITFIELD	BITS		DESCRIPT	ION			D	ECODE	
DIAG	5:4	diagnostic m	agnostics. Aften node, read the comparator state	STATM registe	er to	00 = Normal mode 01 = Short MD1 comparator inputs to ground and MD2 comparator inputs to V_{SUP} 10 = Short MD1 comparator inputs to V_{SUP} and MD2 comparator inputs to GND 11 = Reserved			
WCC2	3:2	MD2 pin. Th	e STATM shou	ne mode of the uld be read whe a correct readi	en ing.	01 = Lor divider o 10 = Hig divider o 11 = Re	etting current ar w-side wetting disabled gh-side wetting disabled sistor-divider e	current enablec	l and resistor d and resistor
WCC1	1:0	MD1 pin. Th	e STATM shou	ne mode of the uld be read whe a correct readi	en ing.	disabled 00 = Wetting current and resistor divider disable 01 = Low-side wetting current enabled and resist divider disabled 10 = High-side wetting current enabled and resist divider disabled 11 = Resistor-divider enabled and wetting current disabled			l and resistor d and resistor

FPSCFG1 (0x5)

Flexible Power Sequencer Configuration Register 1 (Read/Write, Protected: writeable when LOCK = 0)

BIT	7	6	5	4	3	2	1	0
Field	PU4	[1:0]	PU3	8[1:0]	PU2	[1:0]	-	-
Reset	0.	TP	0.	TP	0	ГР	-	-
Access Type	Write,	Read	Write,	Read	Write,	Read	-	-

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BITFIELD	BITS	DESCRIPTION	DECODE
PU4	7:6	OUT4 Power-Up Time Slot. OUT4 powers up in time slot set by PU4[1:0].	t _{PU4} = PU4[1:0] x 2.44 x (2 ^{TS[1:0]}) ms
PU3	5:4	OUT3 Power-Up Time Slot. OUT3 powers up in time slot set by PU3[1:0].	t _{PU3} = PU3[1:0] x 2.44 x (2 ^{TS[1:0]}) ms
PU2	3:2	OUT2 Power-Up Time Slot. OUT2 powers up in time slot set by PU2[1:0].	t _{PU2} = PU2[1:0] x 2.44 x (2 ^{TS[1:0]}) ms

PORRST (0x6)

Power On Reset Emulation Register (Read/Write, Protected: writeable when LOCK = 0)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	-	POR_RST
Reset	_	_	_	_	_	_	_	0x0
Access Type	-	-	-	-	-	-	_	Write, Read, Ext

BITFIELD	BITS	DESCRIPTION	DECODE
POR_RST	0	The POR_RST bit emulates a power-on-reset condition, re-initlaizing the FPS sequence and watchdog while retaining programmed register values and performing comparator BIST. OTP CRC calculation is not performed when executing this command. This bit is self-clearing, and cannot be written when LOCK = 1.	0 = No Effect 1 = Initialze POR Emulation

PINMAP1 (0x7)

RESETB Pin Mapping Register (Read/Write, Protected: writeable when LOCK = 0)

BIT	7	6	5	4	3	2	1	0			
Field	_	-		RSTMAP[6:1]							
Reset	_	-		OTP							
Access Type	-	-	Write, Read								
BITFIELD	BITS		DESCRIPT	ION		DECODE					
RSTMAP	5:0	OUT2(RSTM OUT4(RSTM (RSTMAP6)	MAP2), OUT3(MAP4), IN5(RS). ch voltage mor	OUT1(RSTMAF RSTMAP3), STMAP5), and I nitors are mapp	N6 0 = OV 1 = OV	0 = OV[x] and UV[x] not mapped to RESETB pin 1 = OV[x] and UV[x] are mapped to RESETB pin					

STATUV (0x8)

UV Comparator Status Register (Read Clear)

BIT	7	6	5	4	3	2	1	0		
Field	-	-	UV[6:1]							
Reset	-	-	0x0							
Access Type	-	-	Read Clears All							

Four-Output Mini PMIC For Safety Applications

BITFIELD	BITS	DESCRIPTION	DECODE
UV	5:0	UV Comparator Status for OUT1 (UV1), OUT2 (UV2), OUT3 (UV3), OUT4 (UV4), IN5 (UV5), IN6 UV6)	0 = UV[x] is above UV threshold 1 = UV[x] below UV threshold (or passed BIST when exiting POR)

STATOV (0x9)

OV Comparator Status Register (Read Clear)

BIT	7	6	5	4	3	2	1	0			
Field	-	-		OV[6:1]							
Reset	-	-		0x0							
Access Type	_	_		Read Clears All							
BITFIELD	BITS		DESCRIPT	ION		[DECODE				
ov	5:0			OUT1 (OV1), , OUT4 (OV4),	IN5 1 = OV	0 = OV[x] is below OV threshold 1 = OV[x] above OV threshold (or passed BIST when exiting POR)					

STATOFF (0xA)

OFF Comparator Status Register (Read Clear)

BIT	7	6	5	4	3	2	1	0			
Field	-	-		OFF[6:1]							
Reset	-	-		0x0							
Access Type	_	_	Read Clears All								
BITFIELD	BITS		DESCRIPT	ION		[DECODE				
OFF	5:0		2), OUT3 (OFF	r OUT1 (OFF1 53), OUT4 (OFF	4), 1 = OF	0 = OFF[x] is above OFF threshold 1 = OFF[x] is below OFF threshold (or passed BIST when exiting POR)					

STATD (0xB)

Diagnostic Status Register (Read Only, Read Clear)

BIT	7	6	5	4		3	2	1	0	
Field	_	_	_	RSTERR		POR	-	THSD	INTERR	
Reset	_	_	_	0x0			-			
Access Type	-	-	-	Read Clears All				Read Clears All	Read Only	
BITFIELD	BITS		DESCRIPT	ION		DECODE				
RSTERR	4		RESETB Fault. The RESETB pin state is latched into this register when deasserting RESETB.				0 = No fault detected 1 = Short to supply detected during BIST			
POR	3		Power On Reset. Indicates if the device just exited power on reset.				0 = No POR occurred since last read 1 = A POR has occurred since the last read This indicates that all BIST information is available in the status registers			
THSD	1	Thermal Shu	Thermal Shutdown Indication				0 = No thermal shutdown 1 = Thermal shutdown has occurred since last read			

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BITFIELD	BITS	DESCRIPTION	DECODE
INTERR	0	Internal Error	0 = No internal error detected 1 = Internal error detected (OTP CRC failure, OV/ UV comparator test failure)

STATM (0xC)

Mount ID Status Register (Read Only)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	MD2H	MD2L	MD1H	MD1L
Reset	-	-	-	-	0x0	0x0	0x0	0x0
Access Type	-	-	_	_	Read Only	Read Only	Read Only	Read Only

BITFIELD	BITS	DESCRIPTION	DECODE
MD2H	3	Mount ID 2 High Comparator Input Real-Time Status. Note: The WCC2 bits must be set to 11 for this status bit to be valid.	0 = Input is below the threshold 1 = Input is above the threshold
MD2L	2	Mount ID 2 Low Comparator Input Real-Time Status. Note: The WCC2 bits must be set to 11 for this status bit to be valid.	0 = Input is below the threshold 1 = Input is above the threshold
MD1H	1	Mount ID 1 High Comparator Input Real-Time Status. Note: The WCC1 bits must be set to 11 for this status bit to be valid.	0 = Input is below the threshold 1 = Input is above the threshold
MD1L	0	Mount ID 1 Low Comparator Input Real-Time Status. Note: The WCC1 bits must be set to 11 for this status bit to be valid.	0 = Input is below the threshold 1 = Input is above the threshold

STATWD (0xD)

Watchdog Status Register (Read Only, Read Clear). When the watchdog is enabled, these status bits are mapped to the RESET pin and are not maskable.

BIT	7	6	5	4		3	2	1	0	
Field	_	_	RESETB_S WD_C			_OPEN	WD_LFSR	WD_UV	WD_EXP	
Reset	-	_	_	0x0		0x0	0x0	0x0	0x0	
Access Type	-	-	– – Read Only Rea			ad Only	Read Clears All	Read Clears All	Read Clears All	
BITFIELD	BITS		DESCRIPTION				DECODE			
RESETB_ST AT	4	-	RESETB pin. T	verification of t his is the real-t		0 = RESETB is low 1 = RESETB is high				
WD_OPEN	3	that it is perr	Watchdog Open Window. This bit indicates that it is permissable to update the watchdog. This bit shows real-time status.				0 = Watchdog update not open 1 = Watchdog ok to update			
WD_LFSR	2		Mismatch. The rect value to th	MCU/SoC did e WDKEY	not	t 0 = LFSR key match 1 = LFSR key mismatch since last read				

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BITFIELD	BITS	DESCRIPTION	DECODE
WD_UV	1	Watchdog Update Violation. The MCU/SoC wrote to the WDKEY register before t _{wd1} expired.	0 = No violation detected 1 = Watchdog updated too early
WD_EXP	0	Watchdog Open Window Expired. The MCU/ SoC did not write to the WDKEY register before t _{wd2} expired.	0 = Watchdog timer not expired 1 = Watchdog timer expired

<u>VOUT2 (0xE)</u>

OUT2 Output Voltage Register (Read/Write, Protected: writeable when LOCK = 0)

BIT	7	6	5	4	3	2	1	0		
Field	OUT2[7:0]									
Reset		OTP								
Access Type		Write, Read								
BITFIELD	BITS	BITS DESCRIPTION DECODE								
OUT2	7:0	OUT2 Volta	ge Setting		V _{OUT2} = OUT2[7:0] x 12.5mV + 0.800V (0.8V 3.9875V)					

<u>VOUT4 (0xF)</u>

OUT4 Output Voltage Register (Read/Write, Protected: writeable when LOCK = 0)

BIT	7	6	5	4	3	2	1	0		
Field	OUT4[7:0]									
Reset		OTP								
Access Type	Write, Read									
BITFIELD	BITS		DESCRIPT	ION		D	ECODE			
OUT4	7:0	OUT4 Volta	JT4 Voltage Setting V _{OUT4} = OUT4[7:0] x 12.5mV + 0.800V (0.8 3.9875V)					OV (0.8V to		

<u>VIN5 (0x10)</u>

IN5 Input Voltage Monitor Register (Read/Write, Protected: writeable when LOCK = 0)

BIT	7	6	5	4	3	2	1	0	
Field	IN5[7:0]								
Reset		OTP							
Access Type		Write, Read							
BITFIELD	BITS		DESCRIPT	ION		D	ECODE		
IN5	7:0	Input 5 Volta	Itage Monitor Setting V _{IN5} = IN5[7:0] x 12.5mV + 0.800V (0.8V 3.9875V)				0.8V to		

<u>VIN6 (0x11)</u>

IN6 Input Voltage Monitor Register (Read/Write, Protected: writeable when LOCK = 0)

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BIT	7	6	5	4	3	2	1	0		
Field		IN6[7:0]								
Reset		OTP								
Access Type		Write, Read								
BITFIELD	BITS DESCRIPTION DECODE									
IN6	7:0	Input 6 Volta	age Monitor Se	tting		V _{IN6} = IN6[7:0] x 12.5mV + 0.800V (0.8V to 3.9875V)				

WDCDIV (0x12)

Watchdog Clock Divider Register (Read/Write, Protected: writeable when WDLOCK = 0)

** If the watchdog is enabled this register should only be updated once before the first watchdog update after exiting RESET to prevent a possible watchdog violation.

BIT	7	6	5	4	3	2	1	0		
Field	-	WD_SWW	WD_DIV[5:0]							
Reset	-	OTP	OTP							
Access Type	-	Write, Read	Write, Read							
BITFIELD	BITS		DESCRIPT	ION		D	ECODE			
WD_SWW	6	Simple Wind	lowed Watchde	og Enable		0 = Challenge/response watchdog enabled 1 = Standard windowed watchdog enabled				
WD_DIV	5:0	Watchdog C	ock Divider t _{WDCLK} = (WD_DIV[5:0]+1) x 121.905µs							

WDCFG1 (0x13)

Watchdog Configuration Register 1 (Read/Write, Protected: writeable when WDLOCK = 0)

** If the watchdog is enabled this register should only be updated immediately following a refresh to prevent a possible watchdog violation.

BIT	7	6	5	4	3 2 1 0					
Field		WD_OPN[3:0] WD_CLO[
Reset		0	ΓP			OTP				
Access Type		Write,	Read		Write, Read					
BITFIELD	BITS		DESCRIPT	ΓΙΟΝ	DECODE					
WD_OPN	7:4		ock cycles bef	en Window. Sets the number of k cycles before the open $t_{WD1} = t_{WDCLK} \times (WD_OPN[3:0]+1) \times 8$						
WD_CLO	3:0		ock cycles bef	Sets the numbe fore the close		of $t_{WD2} = t_{WD1} + t_{WDCLK} \times (WD_CLO[3:0]+1) \times$				

WDCFG2 (0x14)

Watchdog Configuration Register 2 (Read/Write, Protected: writeable when WDLOCK = 0)

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BIT	7	6	5	4		3	2	1	0	
Field	_	-	V			/D_EN WD_1UD[2:0]				
Reset	_	-	-	-		OTP OTP				
Access Type	_	-	_	-	Wri	Write, Read Write, Read				
BITFIELD	BITS		DESCRIPT	ION		DECODE				
WD_EN	3	Watchdog E	inable			0 = Disabled 1 = Enabled				
WD_1UD	2:0		First Update Extension. Sets the number of extra t _{WD2} cycles after POR to the normal t _{ND2} = t _{WD2} x (WD_1UD[2:0] + 1))	

WDKEY (0x15)

Watchdog Key Register (Read/Write)

BIT	7	6	5	5 4 3 2 1 0								
Field				WD_K	EY[7:0]							
Reset				0x	AA							
Access Type	Write, Read, Ext											
BITFIE	LD	BITS		DESCRIPTION								
BITTIELD BITS Description Watchdog Key. The current key can be read from this regis watchdog, the next value in the sequence must be written If configured as a simple windowed watchdog, writing any WDKEY register will refresh the watchdog and the value w ignored. WD_KEY 7:0 If configured as a challenge/response watchdog, writing the response to the WDKEY register will result in the value wri and a WD_LFSR violation. Writing the correct response in response mode during an open window will result in a refree WDKEY register being updated. Writing the correct response response mode during a closed window will result in the will and a WD_UV violation.						e written to this iting any value e value written writing the inco value written b ponse in challe t in a refresh an ct response in	s register. to the will be prrect being ignored enge/ nd the challenge/					

WDPROT (0x16)

Watchdog Lock Protect Register (Read/Write)

BIT	7	6	5	4	3		2	1	0		
Field	-	-	-	-	-		-	-	WD_PROT		
Reset	_	_	-	-	_		-	-	0x0		
Access Type	-	-	-	-	_		_	-	Write, Read		
BITFIELD	BITS		DESCRIPT	ION		DECODE					
WD_PROT	0	Watchdog L	Watchdog Lock Protection				on 0 = Watchdog configuration registers are writeable 1 = Watchdog configuration registers are read-only				

Applications Information

Input Capacitors

The input-bypass filter capacitors reduce peak currents drawn from the power source, as well as noise and voltage ripple on the input caused by the circuit's switching. A 4.7μ F X7R ceramic capacitor is recommended for V_{SUP}, PV2, PV4, and for the input of the boost converter. See Typical Application Circuit for reference.

Inductor Selection

The MAX20430 design is optimized to be used with inductor values shown in <u>Table 1</u>. The saturation current rating should be higher than the peak current limit (max) for the respective converter. See the Typical Application Circuit for reference.

Table 1. Inductor Selection

INDUCTOR	VALUE	UNIT
L1	2.2	μH
L2	0.47 - 0.68	μH
L3	1.0	μH
L4	0.47 - 0.68	μH

Output Capacitors

The MAX20430 DC-DC converters are designed to be stable with low-ESR ceramic capacitors. Other capacitor types are not recommended, as the ESR zero can affect stability of the device. The nominal recommended value for each part number is shown in <u>Table 2</u>. The de-rated capacitance should not fall below the minimum value. The phase margin and transients must be measured in the final circuit to verify that proper stability is achieved.

Table 2. Output Capacitor Selection

OUTPUT	MINIMUM VALUE	NOMINAL VALUE	UNIT
C _{OUT1}	15	47	μF
C _{OUT2}	10.5 x I _{OUT(MAX)} /V _{OUT}	27.5 x I _{OUT(MAX)} /V _{OUT}	μF
C _{OUT3}	12	22	μF
C _{OUT4}	10.5 x I _{OUT(MAX)} /V _{OUT}	27.5 x I _{OUT(MAX)} /V _{OUT}	μF

Typical Application Circuits

Typical Application Circuit



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Ordering Information

PART	CID	V _{OUT2}	V _{OUT4}	I _{OUT2}	I _{OUT4}	CONFIG1	CONFIG2	FPSCFG1	I ² C
MAX20430ATIBB/ VY+*	0x10	1.1V (0x18)	1.8V (0x50)	ЗA	3A	0x04	0x21	0x00	0x38
MAX20430ATIA/ VY+	0x01	1.2V (0x20)	1.0V (0x10)	3A	3A	0x05	0x21	0x00	0x38
MAX20430ATICA /VY+*	0x03	1.2V (0x20)	1.35V (0x2C)	3A	3A	0x04	0x61	0x00	0x38

/VY Denotes side-wettable automotive qualified parts

+ Denotes a lead(Pb)-free/RoHS-compliant package

T Denotes tape-and-reel

* Future product - contact factory for availability

Contact factory for other sequence options

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Revision History

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
0	10/19	Initial release	—

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at https://www.maximintegrated.com/en/storefront/storefront.html.

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